

ATTENTION
OBSERVE PRECAUTIONS
FOR HANDLING
ELECTROSTATIC
DISCHARGE
SENSITIVE
DEVICES

HL-120H203BC

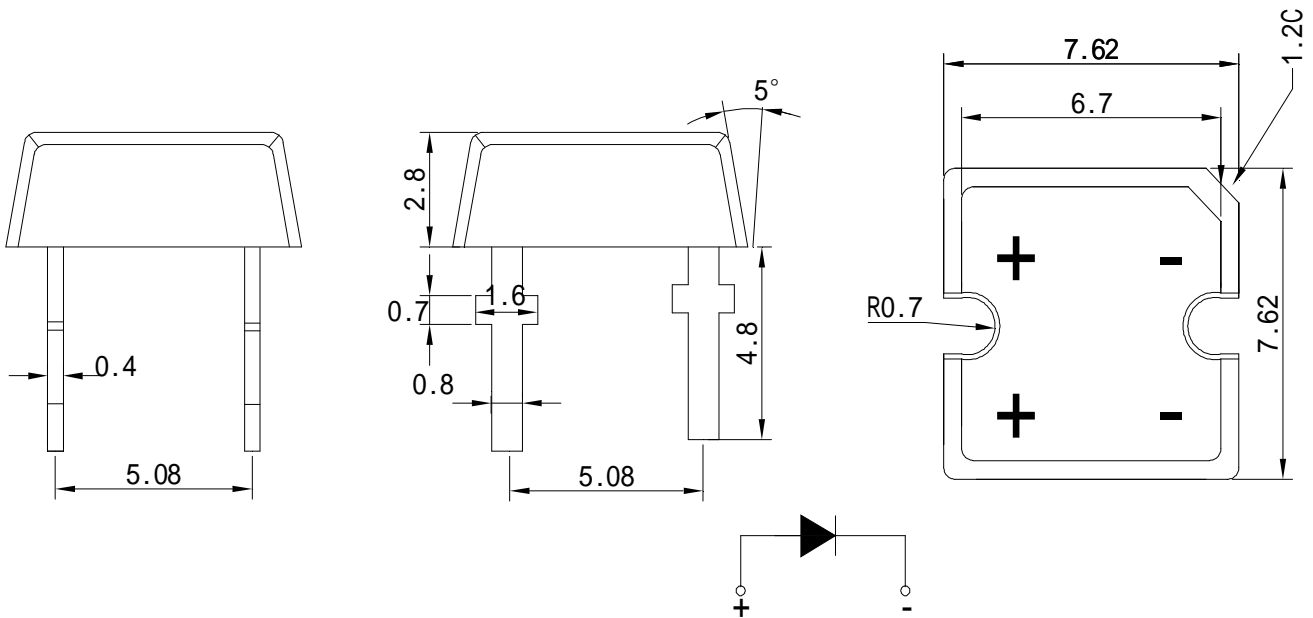


Features

- Super Flux LED.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- PACKAGE: 60PCS / PIPE.

Package Dimensions

This devices are made with TS GaN.



Tolerance Grade	Dimension Tolerance (UNIT:mm)			
	0.5~3	3~6	6~30	30~120
	±0.1	±0.2	±0.3	±0.5
Chip		Lens Color		
Material	Emitting Color	Water Clear		
GaN	Blue			

■ Absolute Maximum Rating

Item	Symbol	Value	Unit
Forward Current	I _F	20	mA
Peak Forward Current*	I _{FP}	100	mA
Reverse Voltage	V _R	5	V
Power Dissipation	P _D	80	mW
Electrostatic discharge	E _{SD}	600	V
Operation Temperature	T _{opr}	-30~+80	°C
Storage Temperature	T _{stg}	-30~+80	°C
Lead Soldering Temperature*	T _{sol}	Max. 260°C for 5sec Max.	

*I_{FP} Conditions: Pulse Width ≤ 10msec

*T_{sol} Conditions: 3mm from the base of the epoxy bulb

■ Typical Optical/ Electrical Characteristics Ta=25°C

Item	Symbol	Condition	Rank	Min.	Typ.	Max.	Unit
Luminous Intensity	I _v	I _F =20mA	L	160		210	mcd
			M	210		276	mcd
			N	276		355	mcd
Forward Voltage	V _F			2.8	3.2	3.6	V
Viewing Angle	2θ 1/2			--	130	--	deg
Luminous Flux	φ _V				0.8	--	lm
Prpc Wavelength	λ _D			465	--	475	nm
Recommend Forward Current	I _F (rec)	--		--	--	20	mA
Reverse Current	I _R	V _r =5V		--	--	10	uA

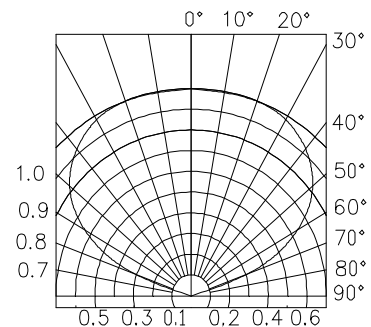
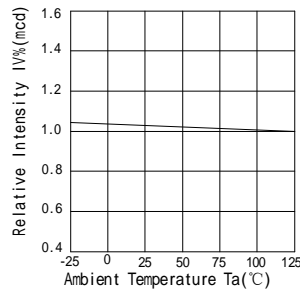
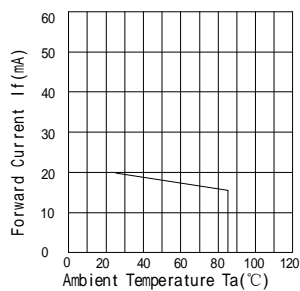
Notes:

Tolerance : V_F ± 0.1V, λ_d ± 2 nm, I_V(φ_V) ± 15%, 2θ 1/2 ± 15%

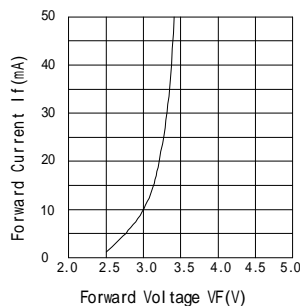
■ Reliability Performance Test Items And Result

Test Classification	Test Item	Test Conditions	Test Duration	Sample Size	AC/RE
Life Test	Room Temperature DC Operating Life Test	Ta=25°C±5°C, I _F =20mA	1000hrs	22 pcs	0/1
Environment Test	Thermal Shock Test	100°C±5°C 5min ↑ ↓ -40°C±5°C 5min.	100cycles	22 pcs	0/1
	Temperature Cycle Test	100°C±5°C 30min ↑ ↓5min -40°C±5°C 30min.	100cycles	22 pcs	0/1
	High Temperature & High Humidity Test	85°C ±5°C/85% RH I _F =5mA	1000hrs	22 pcs	0/1
	High Temperature Storage	Ta=100°C ±5°C	1000hrs	22 pcs	0/1
	Low Temperature Storage	Ta=-40°C ±5°C	1000hrs	22 pcs	0/1
Mechanical Test	Resistance to Soldering Heat	Temp=260°C max T=5sec max	1times	22 pcs	0/1
	Lead Integrity	Load 2.5N(0.25kgf) 0° ~ 90° ~0°	3times	22 pcs	0/1

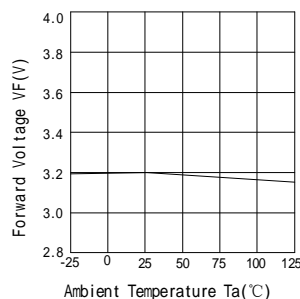
Forward Current vs. Ambient Temperature Relative Intensity vs. Ambient Temperature



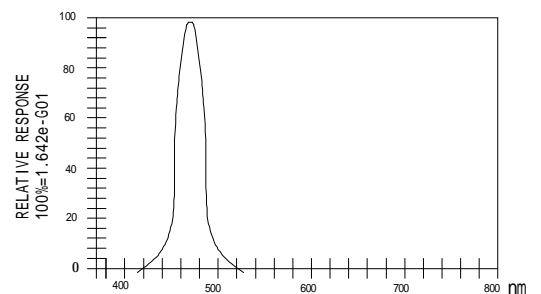
Forward Current vs. Forward Voltage



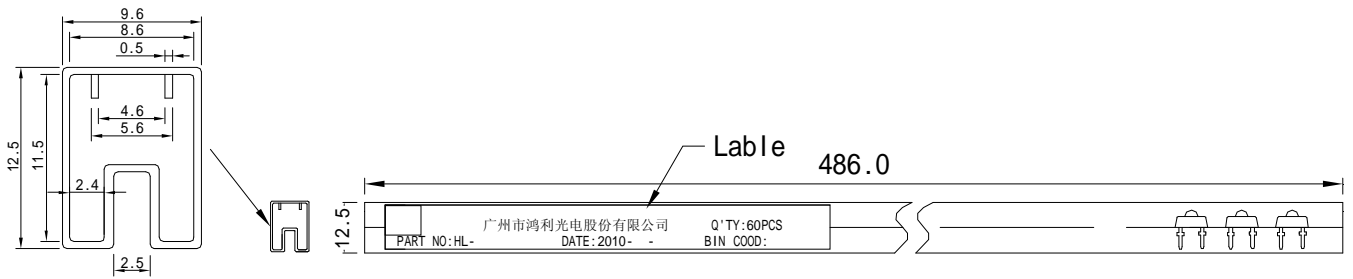
Forward Voltage vs. Ambient Temperature



Luminous Spectrum (Ta=25°C) SPECTRAL RADIANCE



Package means



Notes: Each Adhesive Pipe 60pcs.

Soldering:

1. Manual Of Soldering

The temperature of the iron tip should not be higher than 300°C and Soldering within 3 seconds per solder-land is to be observed.

2. DIP soldering (Wave Soldering):

Preheating: 120°C~150°C, within 120~180 sec.

Operation heating: 245°C ± 5°C within 5 sec. 260°C (Max)

Gradual Cooling (Avoid quenching).

